



VMDSEMI

VUDA003R42ANA

Datasheet



VMDSEMI

General Description

| | | |
|---------------|--------------------|-------|
| $V_{(BR)DSS}$ | $R_{DS(ON)_{max}}$ | I_D |
| 30V | 420mΩ@4.5V | 0.6A |
| | 540mΩ@2.5V | |

Symbol

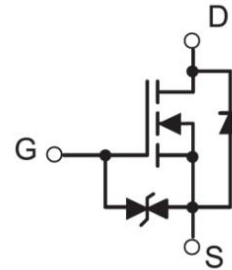


Figure 1 Symbol of VUDA003R42ANA

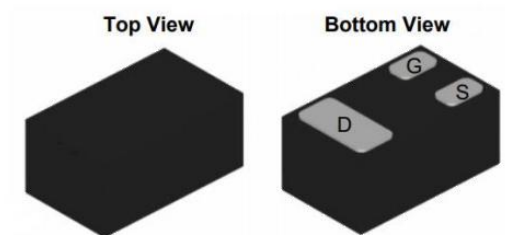
Features

- N-Channel Switch with Low $R_{DS(on)}$
- Surface Mount Package
- Operated at Low Logic Level Gate Drive

Package Type

Application

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift



DFN1006-3L

Figure 2 Package Type of VUDA003R42ANA

Ordering Information

| Product Name | Package |
|---------------|------------|
| VUDA003R42ANA | DFN1006-3L |

Absolute Maximum Ratings ($T_A=25\text{ }^\circ\text{C}$, unless otherwise specified)

| Parameter | Symbol | Rating | Unit |
|--|-----------|------------|------------------|
| Drain-Source Voltage | V_{DSS} | 30 | V |
| Gate-Source Voltage | V_{GSS} | ± 12 | V |
| Continuous Drain Current ^{Note1} | I_D | 0.6 | A |
| Pulsed Drain Current ($t_p=10\mu\text{s}$) | I_{DM} | 1.8 | A |
| Total Power Dissipation ^{Note2} | P_D | 100 | W |
| Junction Temperature | T_J | 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{STG} | -55 to 150 | $^\circ\text{C}$ |

Thermal Resistance

| Parameter | Symbol | Min | Typ | Max | Unit |
|--|-----------------|-----|-----|-----|---------------------------|
| Thermal Resistance, Junction-to-Ambient ^{Note1} | $R_{\theta JA}$ | | 125 | | $^\circ\text{C}/\text{W}$ |



Electrical Characteristics ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--|--------------|-------------------------------|-----|------|---------|---------|
| Statistic Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 30 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=20V, V_{GS}=0V$ | | | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS} = \pm 10V, V_{DS}=0V$ | | | ± 3 | μA |
| Gate Threshold Voltage ^{Note3} | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 0.5 | 1.0 | 1.5 | V |
| Static Drain-Source On-Resistance ^{Note3} | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=0.6A$ | | 320 | 420 | mΩ |
| | | $V_{GS}=2.5V, I_D=0.3A$ | | 410 | 540 | |
| Forward transconductance ^{Note3} | g_{FS} | $V_{DS}=5V, I_D=0.5A$ | | 1 | | S |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{ISS} | $V_{DS}=10V$ | | 44 | | pF |
| Output Capacitance | C_{OSS} | $V_{GS}=0V$ | | 15 | | pF |
| Reverse Transfer Capacitance | C_{RSS} | $f=1MHz$ | | 8 | | pF |
| Total gate charge | Q_g | $V_{DS}=10V$ | | 1.2 | | nC |
| Gate-source charge | Q_{gs} | $V_{GS}=4.5V$ | | 0.28 | | nC |
| Gate-drain charge | Q_{gd} | $I_D=0.8A$ | | 0.3 | | nC |
| Switching Parameters | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DS}=15V$ | | 5.0 | | ns |
| Turn-on Rise Time | t_r | $V_{GS}=4.5V$ | | 8.2 | | |
| Turn-off Delay Time | $t_{d(off)}$ | $I_D=0.7A$ | | 23 | | |
| Turn-off Fall Time | t_f | $R_G=51\Omega$ | | 41 | | |
| Diode Characteristics | | | | | | |
| Diode Forward Voltage ^{Note3} | V_{SD} | $V_{GS}=0V, I_S=0.6A$ | | 0.87 | 1.2 | V |

Notes :

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at $T_a=25^\circ\text{C}$.
3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 0.5\%$.

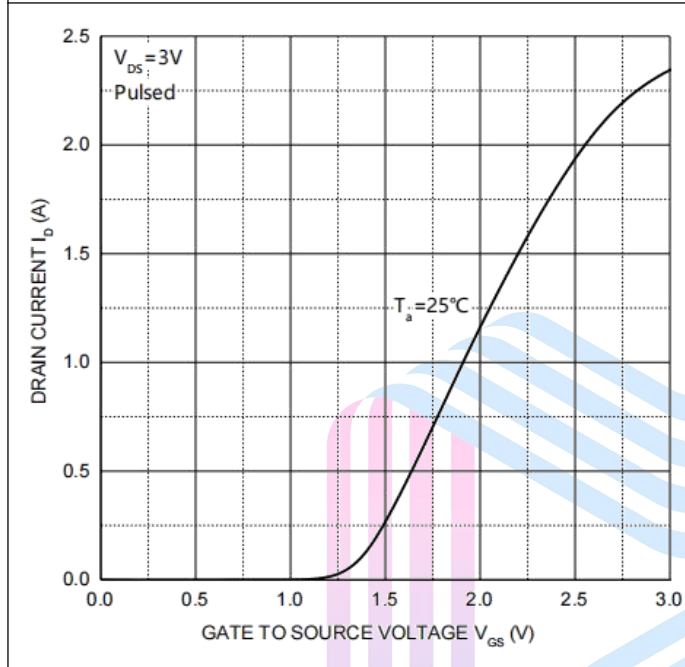
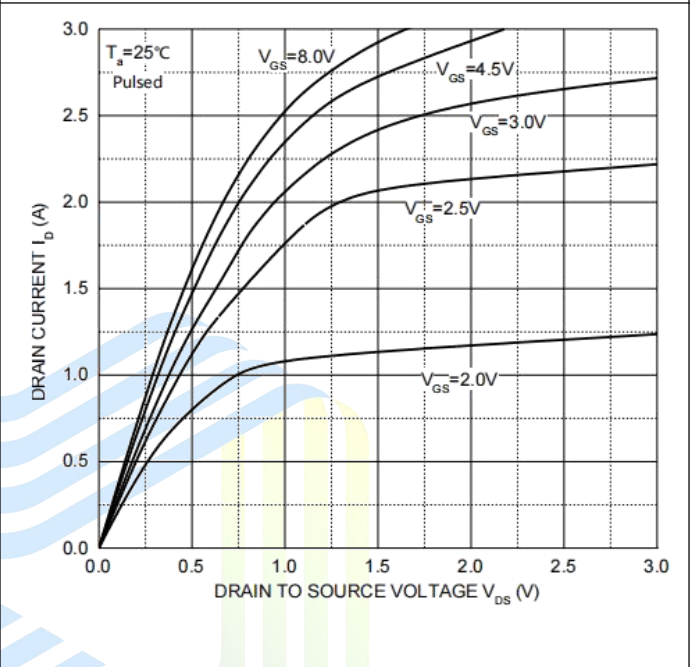
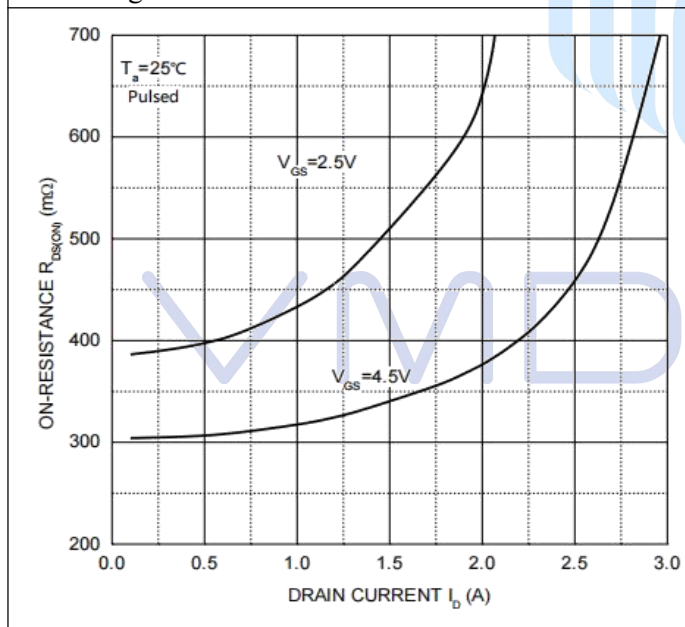
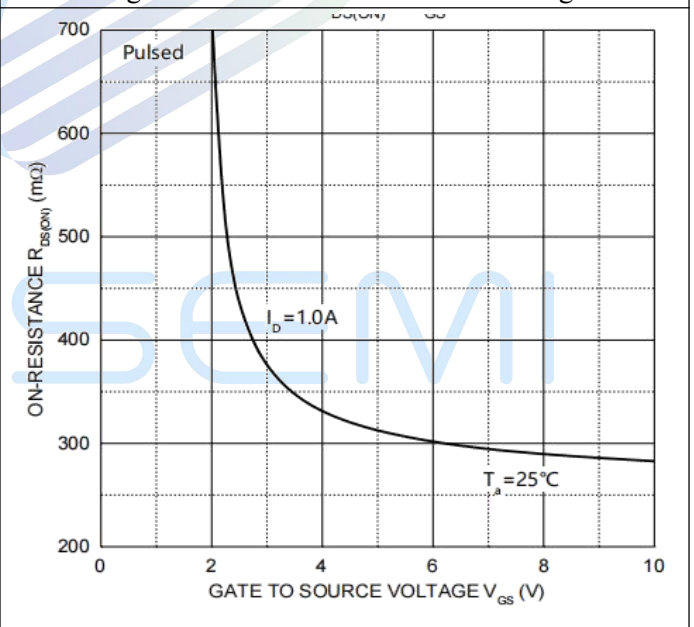
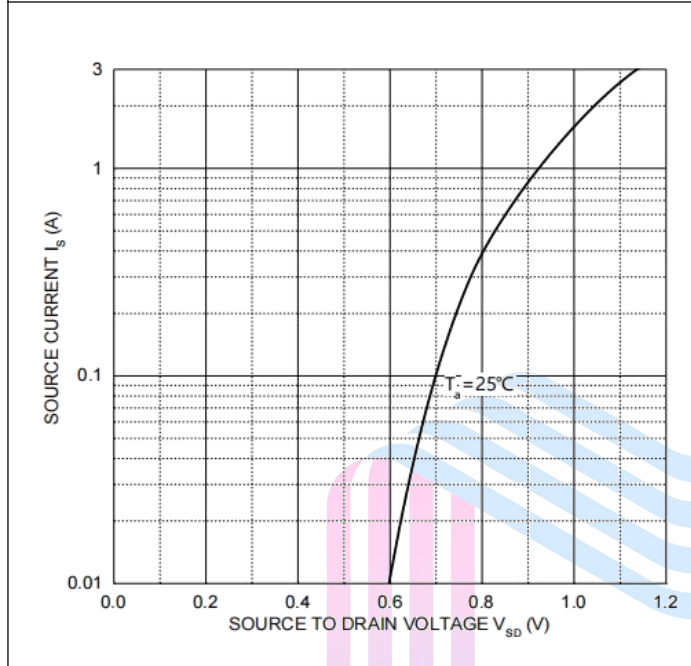
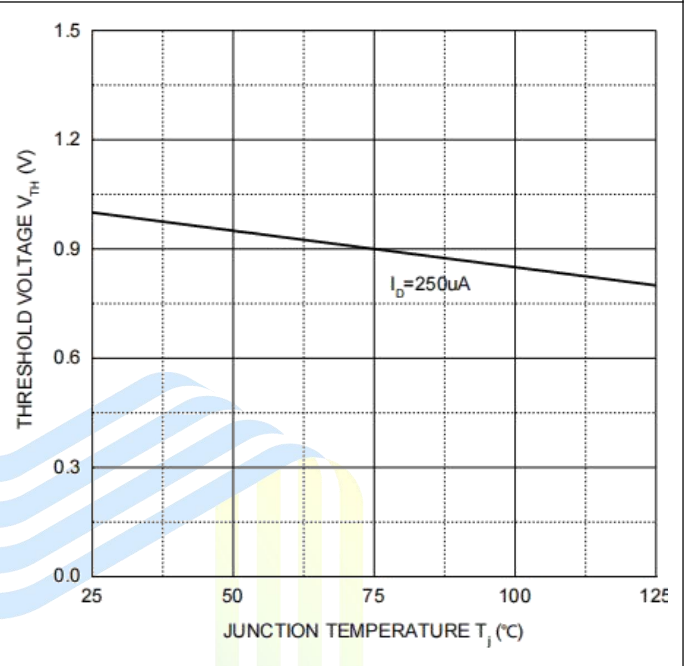
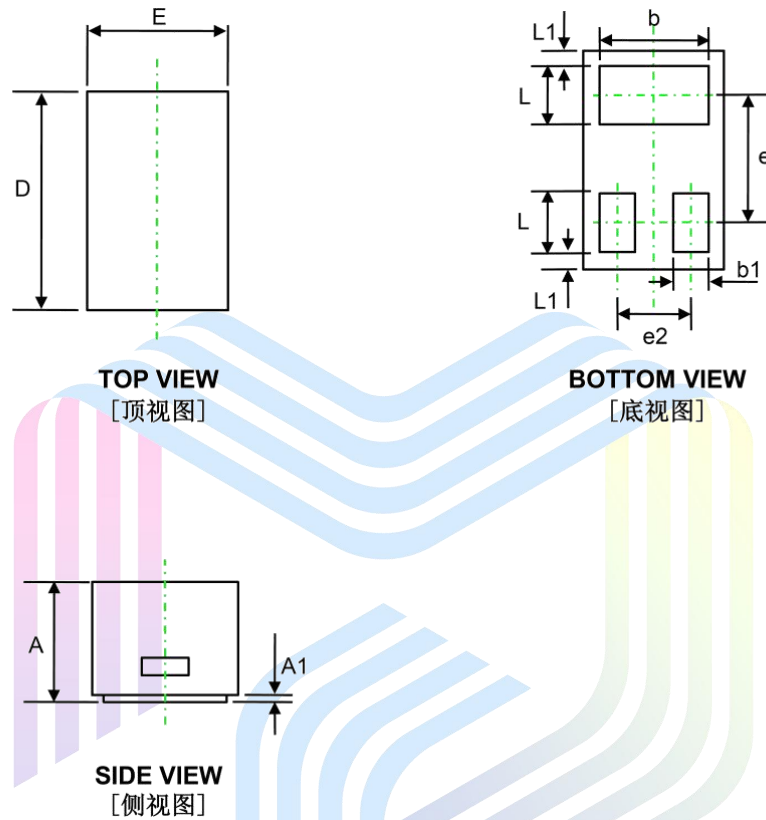
Typical Performance Characteristics
Figure 3: Transfer Characteristics

Figure 4: Output Characteristics

Figure 5: On-Resistance vs. Drain Current

Figure 6: On-Resistance vs. Gate Voltage


Figure 7: Body Diode Characteristics

Figure 8: Threshold Voltage



Mechanical Dimensions:
DFN1006-3L Package Information


| Symbol | Dimensions In Millimeters (mm) | | |
|--------|--------------------------------|------|------|
| | Min. | Typ. | Max. |
| A | 0.40 | 0.47 | 0.55 |
| A1 | 0.00 | 0.03 | 0.05 |
| D | 0.95 | 1.00 | 1.05 |
| E | 0.55 | 0.60 | 0.65 |
| b | 0.40 | 0.50 | 0.60 |
| e | - | 0.65 | - |
| e2 | - | 0.35 | - |
| L1 | 0.05 REF. | | |
| L | 0.20 | 0.25 | 0.30 |
| b1 | 0.10 | 0.15 | 0.20 |

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